

Features

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Lead Free Finish/RoHS Compliant(Note 1) ("P" Suffix Designates Compliant. See Ordering Information)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Low Switching Losses and High Efficiency
- Low Reverse Leakage
- Ultrafast Recovery Time
- Planar Structure Die and Soft Recovery Characteristics

Maximum Ratings @ 25°C (Unless Otherwise Specified)

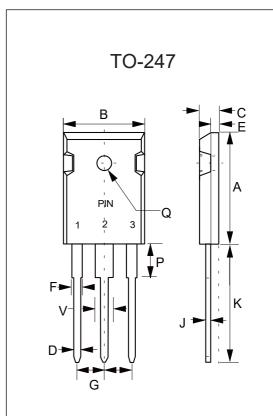
Parameter	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage	V_{RRM}			
Working Peak Reverse Voltage	V _{RWM}	300	V	
DC Blocking Voltage	V _R			
RMS Reverse Voltage	V _{RMS}	210	V	
Average Rectified Forward Current				
Per Diode	I	30	Α	
Per Device	I _{F(AV)}	60		
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave(Per Diode)	I _{FSM}	350	А	
Current Squared Time @ 1ms≤t≤8.3ms(Per Diode)	I ² t	508	A ² s	

Internal Structure

Simplified Outline	Graphic Symbol
MCC. MUR6030PTS → 1 2 3	PIN 1 o PIN 2 PIN 3 o Case

Note: 1. High Temperature Solder Exemption Applied, See EU Directive Annex 7a.

60 Amp FRED Rectifiers 300 Volts



	DIMENSIONS							
DIM	DIM INCHES MIN MAX		MM		NOTE			
Dilvi			MIN	MAX	NOIL			
Α	0.787	0.866	20.00	22.00				
В	0.598	0.638	15.20	16.20				
С	0.185	0.208	4.70	5.30				
D	0.035	0.059	0.90	1.50				
E	0.059	0.094	1.50	2.40				
F	0.067	0.091	1.70	2.30				
J	0.019	0.031	0.48	0.80				
K	0.748	0.833	19.00	21.15				
Р	0.122	0.189	3.10	4.80				
Q	0.118	0.150	3.00	3.80	Ф			
V	0.106	0.134	2.70	3.40				
G	0.197	0.224	5.00	5.70				



Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TJ	Operating Junction Temperature Range		-55		175	°C
T _{stg}	Storage Temperature Range		-55		175	°C
Rth _(J-C)	Thermal Resistance from Junction to Case	Per Diode		0.6		°C/W
Rth _(J-A)	Thermal Resistance from Junction to Ambient			38		°C/W

Electrical Characteristics @ 25°C Unless Otherwise Specified(Per Diode)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _F	I _F =30A;T _J =25°C			1.40	V
		I _F =30A;T _J =125°C			1.20	V
Reverse Current	I _R	V _R =300V;T _J =25°C			10	
		V _R =300V;T _J =125°C			200	μA
Junction Capacitance	CJ	V _R =4V;f=1MHz;T _J =25°C		235		pF

Dynamic Recovery Characteristics @ 25°C Unless Otherwise Specified(Per Diode)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
		I _F =0.5A; I _R =1.0A; I _{RR} =0.25A; T _J =25°C			29	40	
		I _F =1A; di/dt=-50A/μs; V _R =30V; T _J =25°C			40		
Reverse Recovery Time	t _{rr}		T _J =25°C		39		ns
			T _J =125°C		62		
Dook Doooyen Cumont		I _F =30A di/dt=-200A/μs V _R =200 V	T _J =25°C		2.7		А
Peak Recovery Current I _R	IRRM		T _J =125°C		9.0		
Reverse Recovery Charge C			T _J =25°C		52		, C
	Q _{rr}		T _J =125°C		275		nC



70

60

50

40

30

20

10

0 0

Average Forward Current (A)

Curve Characteristics

Resistive or Inductive Load

35

Fig. 1 - Forward Current Derating Curve

Fig. 3 - Typical Forward Characteristics

Case Temperature (°C)

105

140

175

70

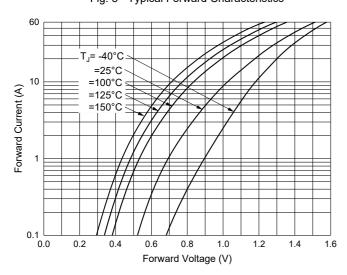


Fig. 5 - Typical Capacitance Characteristics

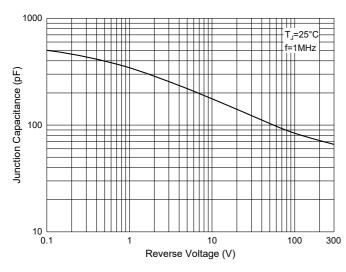


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

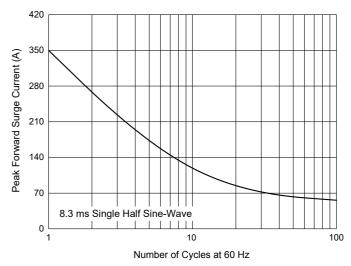


Fig. 4 - Typical Reverse Leakage Characteristics

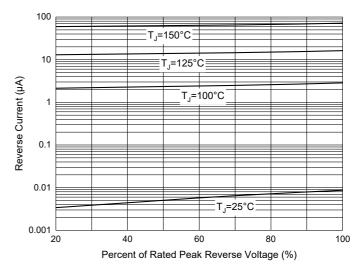
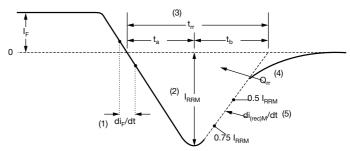


Fig. 6 - Reverse Recovery Waveform and Definitions



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) Q_{rr} area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}



Ordering Information

Device	Packing
Part Number-BP	Bulk:30pcs/Tube,360pcs/Box,1.8Kpcs/Carton

Note: Adding "-HF" Suffix For Halogen Free, eg. Part Number-BP-HF

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